# Key Issues Affecting Water Use & Recycle in HVSM

**Teleseminar By:** 

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### Outline

- Concerns about public water supplies
  - Future availability of water resources
  - Future quality of water resources
- Challenges affecting the semiconductor industry
  - Acquisition of water resources needed for semiconductor manufacturing industry growth
  - *Minimize the industries liability for utilizing materials with poorly characterized environmental and health characteristics*
  - Develop strategies to meet future waste disposal requirements
- Technologies which we are currently investigating that address these concerns and challenges
  - *Replacement of conventional ion exchange materials*
  - POU generation of dilute acid and base from RO concentrate
  - A combined water softening and fluoride treatment process
  - *CMP* wastewater recycle with currently available treatment technologies

# Future Availability of Water Resources

#### Water supplies are being increasingly challenged by:

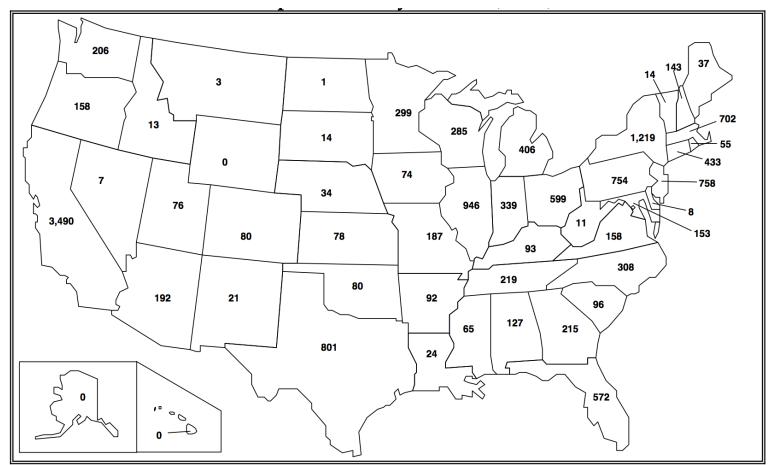
- extended droughts
- water demand growth due to population increase
- more stringent health-based regulations, and
- competing demands from a variety of users

#### Some Quick Facts<sup>1</sup>

- Assuming continued per capita water use, 16 trillion additional gallons per year will be used in the U.S. by 2020. This is equivalent to ¼ of the combined outflow from ALL of the Great Lakes.
- In CA, demands already exceed supplies by 326 billion gallons per year.
- 50% of the growth in the U.S. is forecasted to occur in CA, TX, and FL
   regions already experiencing water shortages.

<sup>1</sup>Desalination and Water Purification Technology Roadmap, 2003

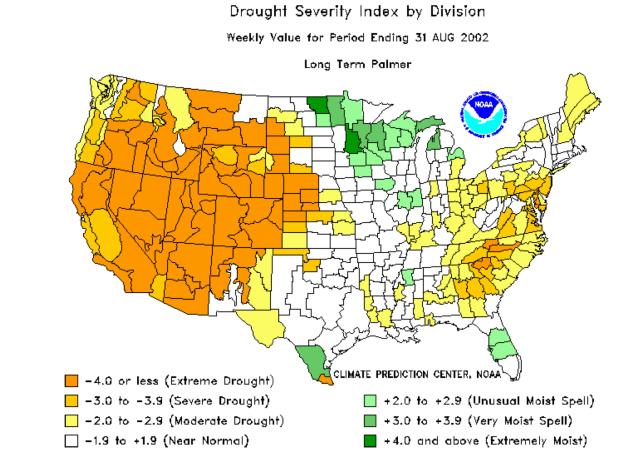
#### **Geographic Distribution of and Number of Companies in the Electronics/Computer Industry**\*



Source: Based on 1992 Bureau of the Census data.

\*USEPA Office of Compliance Sector Notebook Project, Electronics and Computer Industry,1995

# **Drought in the U.S.**



Desalination and Water Purification Technology Roadmap, 2003

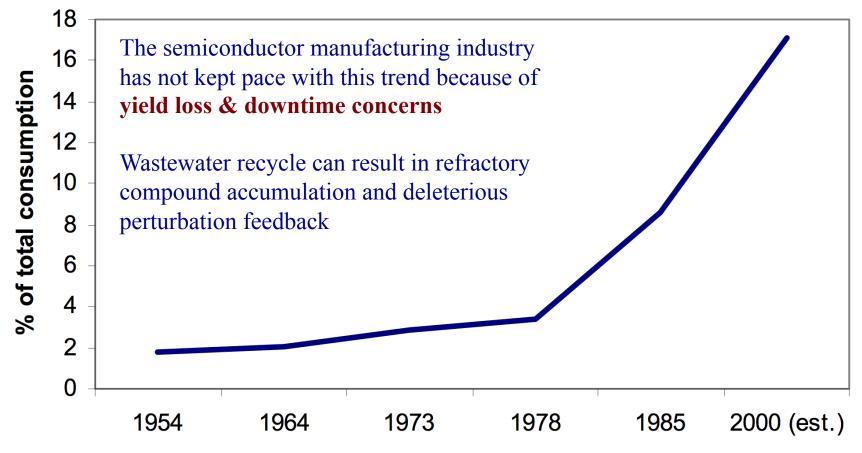
### Water Resource Limitations

"The cause of the plateau in the water use is singular: the withdrawal of fresh water is capped by institutional barriers." per day) Water use (billion gallons Residential Agricultural Industrial Thermoelectric **Total Withdrawals** 

Desalination and Water Purification Technology Roadmap, 2003

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# **Industrial Water Recycling Rate in the U.S.**



Desalination and Water Purification Technology Roadmap, 2003

# The Semiconductor Industry Can Currently Afford Not to Recycle

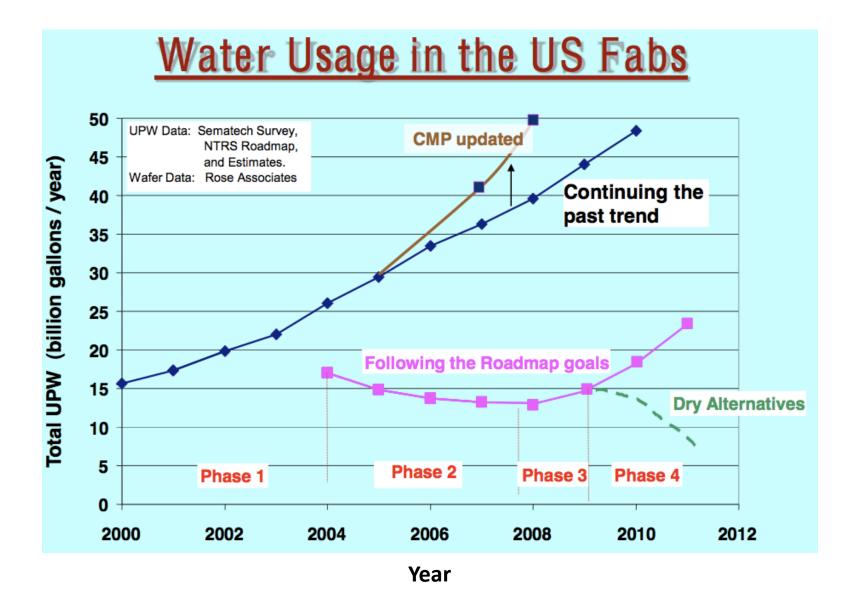
Treatment cost for fresh water from a	\$0.30-0.40/1000
conventional water treatment plant	gallons
Reclaimed water for industry in Southern	\$2.22/1000 gallons
California	
Treatment cost for desalinated brackish	\$1-3/1000 gallons
water for residential use	
Treatment cost desalinated seawater	
Santa Barbara, CA (1992)	\$5.50/1000 gallons
Cyprus-2 (1999)	\$3/1000 gallons
Tampa Bay (2001)	\$2.08/1000 gallons

Desalination and Water Purification Technology Roadmap, 2003

Company	Revenues	Primary products
Intel	\$20,870,000,000	Microprocessors
National Semiconductor	\$ 2,623,100,000	System level products for fax machines, local and
wide-area networking and tele	communications	
Advanced Micro Devices	\$ 1,953,019,000	Microprocessors
Cypress Semiconductor	\$ 528,400,000	Memory chips and programmable logic devices
Cyrix	\$ 183,825,000	Microprocessors
SEEQ Technology	\$ 31,338,000	Local Area Network (LAN) chips
Source: U.S. Securities and E	xchange Commission (SEC	). 1997. Edgar database 10K Reports. Washington, D.C.:

Source: U.S. Securities and Exchange Commission (SEC). 1997. Edgar database 10K Reports. Washington, D.C.: Government Printing Office. Available at http://www.sec.gov/cgi-bin/srch-edgar?

Mazurek, J., 2000 How fabulous fablessness? Environmental challenges of economic restructuring in the semiconductor industry. Greener Management International



#### Slide courtesy Dr. Farhang Shadman

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# **HVSM & Water in the Future**

In the future, the semiconductor industry will be forced to used poorer quality waters.

The semiconductor industry needs technologies that will facilitate cost effective production of UWP from impaired water supplies.

#### &

The net water consumed per wafer must be reduced. Impending regulation will prevent the continued increases in gross water use of HVSM.

- Wastewater recycle appears to better than the alternative water consumption reduction options:
  - process chemistry reformulation, and
  - tool redesign

# **The Safety of Public Waters**

Contamination of water supplies is the result of both human activities and natural processes.

Contaminant removal presents a moving target -- as understanding of contaminant effects improve, regulation governing the acceptable levels of those contaminants become increasingly strict.

**Common Contaminants:** 

- Biologics
- Salts (TDS)
- Metals
- 'Pharmaceutics' (including caffeine and endocrine disruptors)

# New Materials in HVSM & Safety of Public Water Supplies

The semiconductor manufacturing industry is on the cutting-edge of materials application. It is likely to employ materials with poorly characterized environmental and health characteristics.

- Historically: Fluorinated organics (*i.e.*, PFOS)
- Currently: Nanoparticles

Utilization of poorly characterized materials exposes the industry to liabilities:

- Legal action
- Impromptu regulation
  - Processes redesign and retrofit

The technologies developed for HVSM wastewater recycle provide the industry with tools needed to remove materials from the wastewater prior to discharge, allowing the industry to limit these liabilities.

# The Safety of Public Waters & Concentrate Disposal

The technologies commonly used to upgrade the quality of waters produce large quantities of high TDS concentrate.

These concentrates are not always disposed of in a manner that prevents them from reentering the water cycle.

Finding cost and environmentally sensitive disposal options for these concentrates is difficult.

#### **Common Concentrate Disposal Methods**

Currently most concentrate flows are discharged to the sewer.

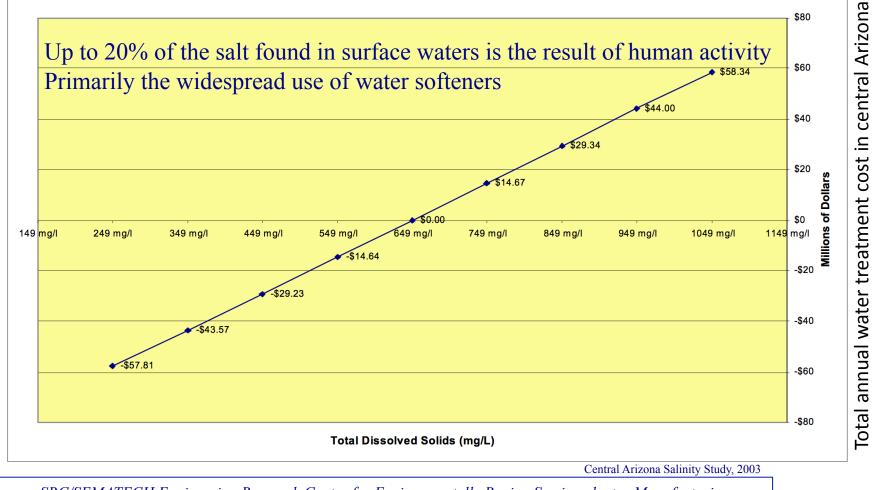
High TDS concentrates discharged to the sewer reenter the public water supply: deep well injection; release to surface waters.

It is not likely that metered discharge to the sewer will continue to be an acceptable concentrate disposal option.

Facility	Type of Water Treatment	Water Treatment Capacity (MGD)	Concentrate Disposal type	Comment
City of Chandler	RO	3	Sewer, and evaporation ponds	This facility treats Intel's waste water. The concentrate is then evaporated in ponds.
City of Scottsdale	RO	12	Sewer	Concentrate is discharged to sewer system, which ultimately ends up at the SROG 91 <sup>st</sup> Avenue WWTP.
City of Gila Bend	RO	1.2	Evaporation Ponds	
Lewis Prison	RO	1.5	Evaporation Ponds	Due to inefficient treatment process, concentrate streams are greater than 15% which makes the ponds undersized
Town of Buckeye	Electrodialysis Reversal	0.9	Sewer	Treatment facility is old and only used for peaking purposes.
Yuma	RO	102	La Cienga By- Pass	Concentrate discharged to the Gulf of California. Plant has not operated since 1993.
City of Goodyear	RO	1.5	Sewer	
Industrial Users	RO	Varies	Sewer	Hospitals, bottling industry and microchip industry utilize treated water in their daily operations.

Central Arizona Salinity Study, 2003

### Annual Costs Due to Changes in Salinity of CAP Water



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### Zero Liquid Discharge (ZLD)

The increasing costs associated with treating high TDS waters are driving municipalities to mandate ZLD.

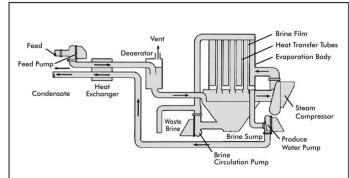
• New Mexico

This will drastically increase the cost of wastewater treatment:

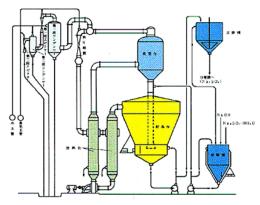
- Brine concentration
- Crystallization
- Evaporation Ponds
- Solids Handling

Central Arizona Salinity Study, 2003

Brine Concentrator Schematic



Crystallizer Schematic



# **Concentrates & HVSM**

HVSM generates large volumes of high TDS concentrate:

- Regeneration of ion exchange softening systems
  - A single regeneration cycle can produce anywhere from 80 to 320 kg of concentrate per cubic meter of ion exchange media
- Reverse Osmosis
  - The concentrate flow from RO units is 10-20% of the feed flow (potable water)

Impending concentrate discharge regulation (*e.g.*, ZLD, *etc.*) will have a significant impact on the semiconductor industry.

Wastewater recycle will reduce concentrate flows:

- HVSM wastewater is soft No ion exchange softening brine
- HVSM wastewater has low TDS Small RO concentrate flow

Technologies which we are currently investigating that address public concerns and semiconductor industry challenges

- Replacement of conventional ion exchange materials
- POU acid and base generation from RO concentrate
- A combined water softening and fluoride treatment process
- CMP wastewater recycle

Elimination of conventional ion exchange materials

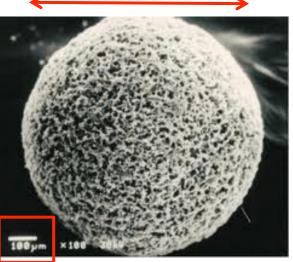
### Softening with FIBAN® IX Fibers

about 0.65 mm



Filaments

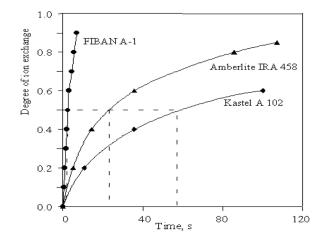
FIBAN®

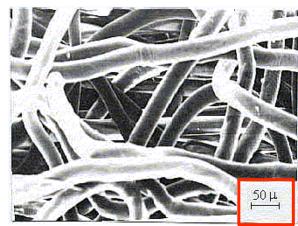


Most IX sites in IX bead interior
poor mass transfer
characteristics

 $\bigcirc IX$  beads require regeneration with concentrated acids –  $pH \sim (-1) = 0$ 

•*Regeneration with concentrated acids produce concentrates* 





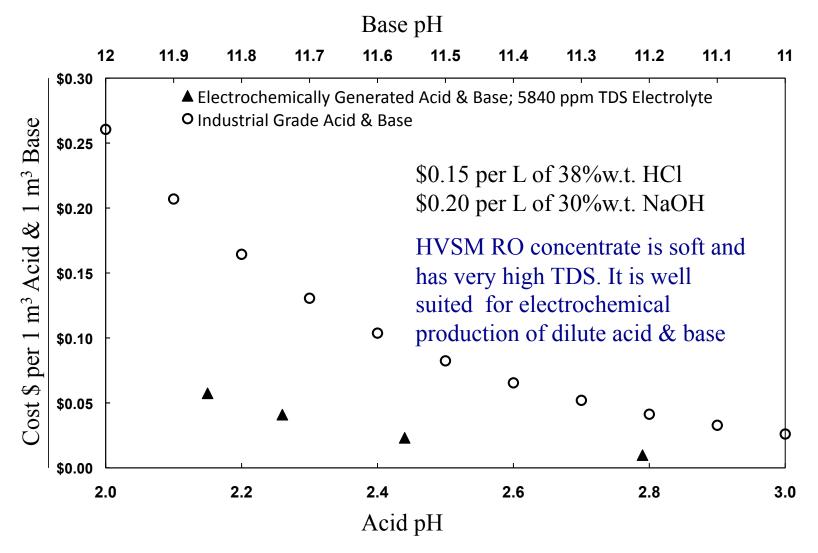
✓ Most IX sites on  $FIBAN^{\mathbb{R}}$  surface – good mass transfer

✓ *FIBAN*<sup>®</sup> can be regenerated at pH~2.5-1.5 (Softening)

✓ Regeneration of FIBAN<sup>®</sup>
 will produce less concentrate

POU acid & base generation

#### Electrochemical Acid & Base Generation



A combined water softening and fluoride treatment processes

### **Current Fluoride Treatment Process**

Treatment of fluoride containing wastewater is most commonly accomplished in two steps:

- 1) reduction of the fluoride concentration to approximately 10ppm by calcium fluoride ( $CaF_{2(s)}$ ) precipitation
  - Coagulation with calcium chloride
  - Flocculation
  - Settling
  - Filtration
  - Disposal of valueless sludge (\$100 per 1000 gal of sludge disposed)
- 2) further reduction of the fluoride concentration to the MCL of 4ppm by sorption with activated alumina
  - Activated alumina must be periodically regenerated with concentrated base

# The Combined Water Softening & Fluoride Treatment Process

#### Two part process:

- 1. Soften the feed water by fluidized bed crystallization resulting in the production of dry calcite pellets (dia. 1.5mm)
  - Reactor feed  $pH \sim 9.5$
- 2. Fluoride containing waste waters are fed through a column containing calcite pellets resulting in the production of chemical grade fluorspar pellets (value: \$500/ton)
  - *Reactor feed pH~ 6.5*
- All pH manipulations can be accomplished with the electrochemical cell

#### Advantages

- No IX regeneration concentrate
- No activated alumina regeneration concentrate
- No Sludge disposal
- Easily handled solids
- \$500 of value added per ton of pellets produced
- Only two pieces of equipment not six
- Columns have no moving parts

#### **Calcite Pellets**



#### CaF<sub>2</sub> Pellets



#### **Discharged Pellets**



### Fluidized Bed Crystallization with Proven DHV Crystalactor<sup>®</sup> Technology

FCB is common practice in the Netherlands WTP (Waternet) since the late 1980s

The fluidized bed reactor is partly filled with seeding material (dia. 0.2-0.4 mm, garnet)

The seeding material in a fluidized condition

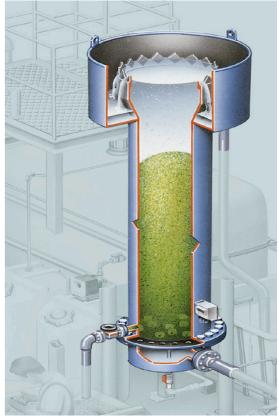
Fluid velocity ~ 2.5 m/min

In the bottom of the reactor, chemicals are dosed (caustic soda, soda ash or lime)

Carbonate & hydroxide minerals rapidly crystallize on the seeding material forming pellets

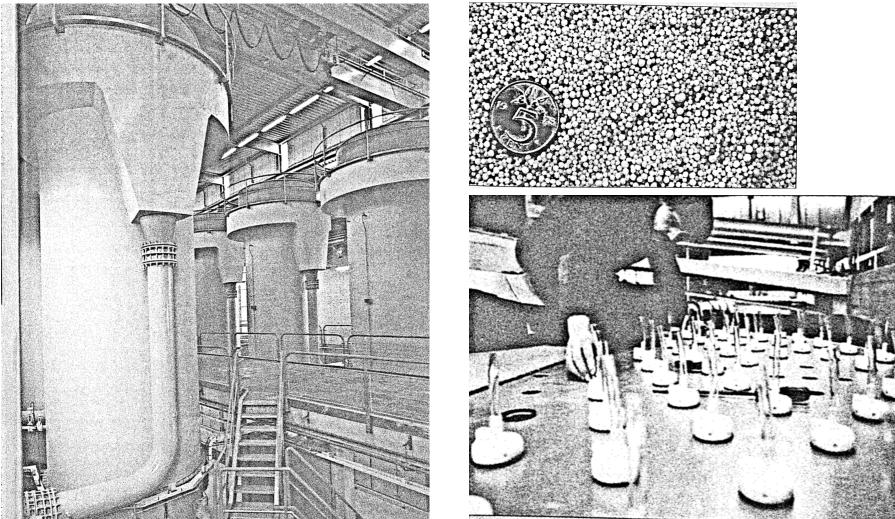
Dry bottom product, solids content of around 99%w.t.

#### DHV Crystalactor®



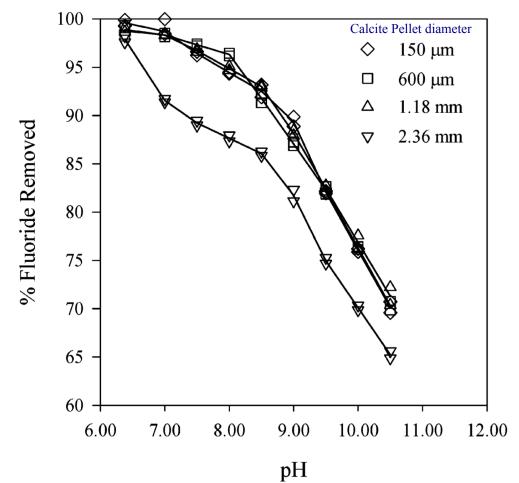
Dijk, J.C. and Wilms, D.A., Water treatment without waste material-fundamentals and state of the art of pellet softening, J.Water SRT-Aqua, 1991, 40, 263-280

#### **Central Softening** in Amsterdam



Narrotor which and installed at 11 . 1

#### Fluoride Removal in a Calcite Column



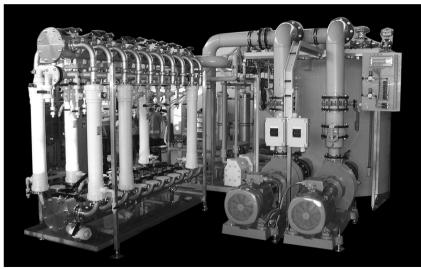


CMP wastewater recycle process

### Current Copper Recovery Technologies

#### Pall Microza<sup>1</sup> Filtration

Actual Capital Cost Data: \$1.5 – \$2.5 Million Actual CoO Data: \$1.90-\$3.10 per kgal treated (excl. Capital & Labor Costs)



#### Siemens Copper Select<sup>TM</sup>

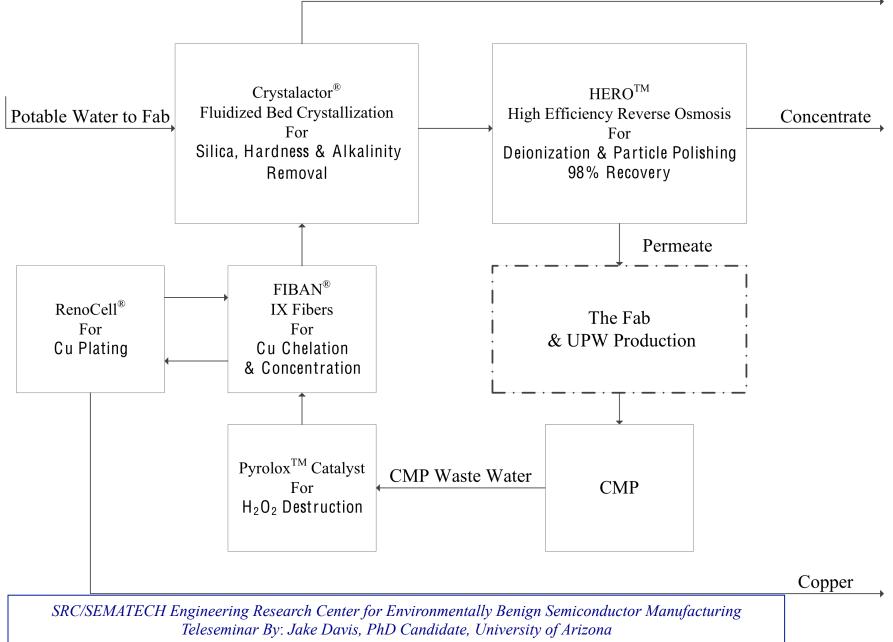
Requires transport of copper laden ion exchange resin off site for regeneration



<sup>1</sup> Microza is a trademark of Asahi Kasei Corporation

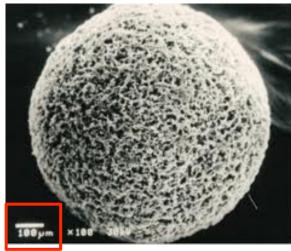
#### New CMP Wastewater Recycle Process

- 1) Cost effective copper recovery using RenoCell<sup>®</sup> technology
- 2) Novel use of  $Pyrolox^{TM}$  technology as a catalyst for  $H_2O_2$  destruction
- 3) Exploitation of new FIBAN<sup>®</sup> fibrous ion exchange technology to eliminate the need for expensive filtration or off-site regeneration of IX resin
- *4)* Application of Crystalactor<sup>®</sup> & HERO<sup>TM</sup> technology to CMP waste water to:
  - *Eliminate silica nanoparticles*
  - Eliminate chelating agents & corrosion inhibitors
  - *Eliminate UPW primary ion exchange for control of:* 
    - *Hardness*
    - Alkalinity
  - *Reclamation of CMP waste water for fab feed water*



### FIBAN<sup>®</sup> Fibrous Ion Exchange Technology

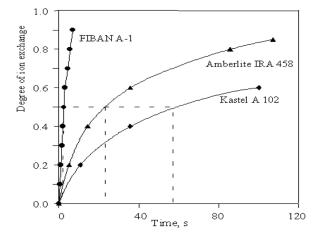
about 0.65 mm

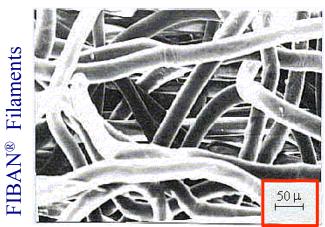


*•Most IX sites in IX bead interior* 

•Silica nanoparticles dissolve and foul bead during normal regeneration

*OIX beads require off-site regeneration* 





✓ Most IX sites on FIBAN<sup>®</sup> surface

✓  $FIBAN^{\mathbb{R}}$  can be regenerated at pH~1.5 (Copper Recovery)

✓ *FIBAN*<sup>®</sup> can be regenerated on-site

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# Porous IX Bead

### Copper Recovery with RenoCell® Technology



RenoCell®

*Electroplating copper with zero acid consumption* 

Acid generation at anode Cu deposition on cathode

Throwaway carbon felt cathode (left)

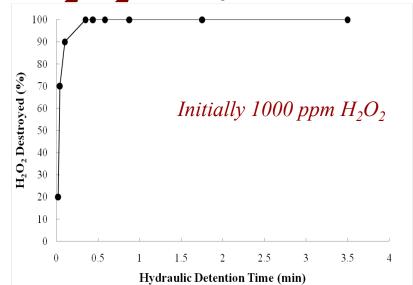
> Copper laden carbon felt cathode from bench reactor (right)

Regeneration of 1 m<sup>3</sup> of 50 mg-Cu per g-resin Recover \$320 of copper (\$4/lb) Costs \$8.40 (\$0.10/kWh)

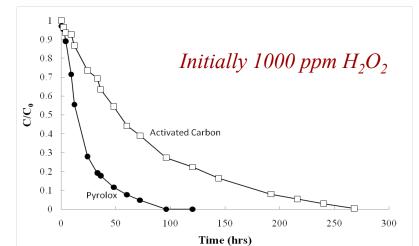


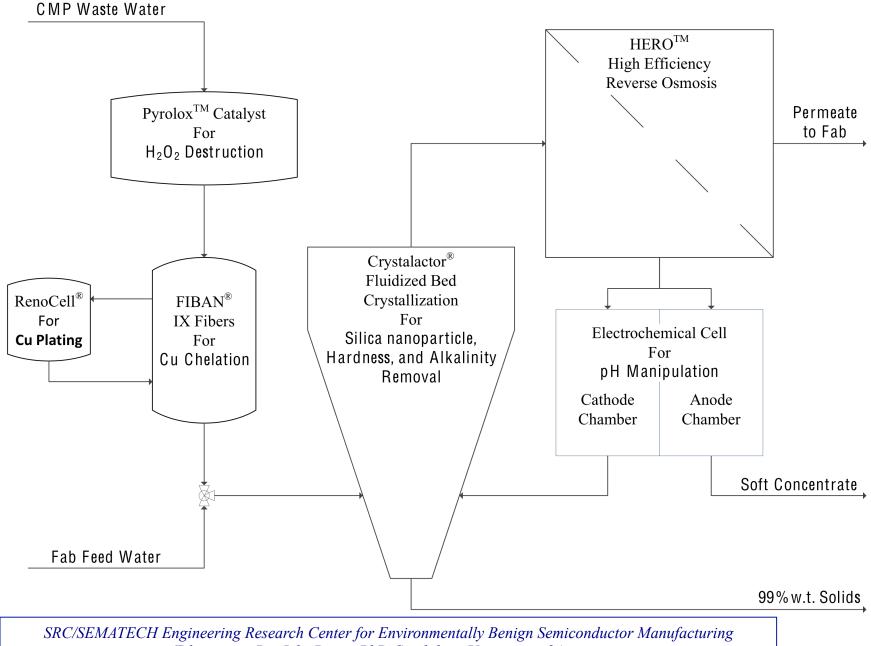
### Catalytic Degradation of $H_2O_2$ with $Pyrolox^{TM}$

- *Pyrolox<sup>TM</sup> (MnO<sub>2</sub>) is granular media commonly used in water treatment*
- *Pyrolox<sup>TM</sup> has proven an effective catalyst for hydrogen peroxide destruction*



- $\circ$  *Pyrolox<sup>TM</sup> is better than GAC* 
  - $\checkmark \quad Pyrolox^{TM} is not fouled by chelators$
  - $\checkmark$  Pyrolox<sup>TM</sup> has faster kinetics
  - ✓ Does not degrade





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# Conclusions

- The quality of water resources made available to the semiconductor industry will decrease with time.
- Regulation governing waste discharge will become more strict with time.
- Currently, the semiconductor industry can afford to not recycle wastewater. But, in the future, regulation will require the utilization of impaired water resources.

# Acknowledgements

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